#### **Direct Manufacturing at ORNL**

- Revolutionary manufacturing technologies in which feed material is added at specific locations to build netshaped components from computer models
- Numerous benefits over conventional processing techniques
  - Decrease Energy and Waste
  - Component Design Optimization
  - Create "Geometrically Impossible Designs"
  - Resurrect US Manufacturing

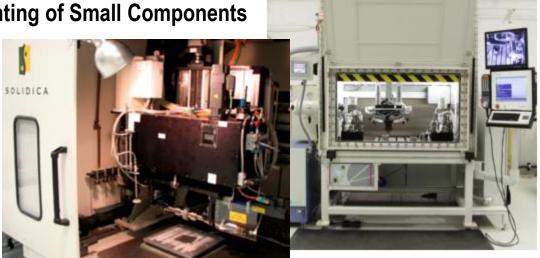




#### **Direct Manufacturing at ORNL**

 The Direct Manufacturing capabilities at ORNL encompasses a broad scope of direct manufacturing technologies including:

- **Electron Beam Deposition (Slide 3)**
- Laser Deposition (Slide 7)
- **Ultrasonic Additive Manufacturing (Slide 10)**
- **Gel Casting**
- Plasma Arc Lamp & IR Technologies
- **Polymer 3D Printing of Small Components**

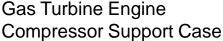


M DMD 103D



### **Electron Beam Deposition:**

- Electron beam used to melt a powder bed under vacuum
- Excellent compositional control with microstructural refinement showing increased mechanical properties
- Precise control of complex geometries
- Many applications including Aerospace, **Automotive, Biomedical**







**Engine Part with** Lattice Structure



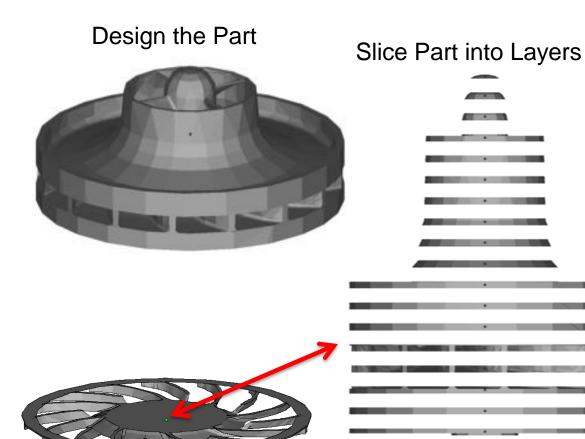
**Customized Trabecular CMF** Implant



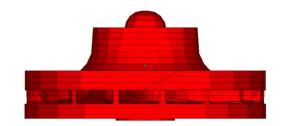




#### **How Arcam Works: Computer Design**



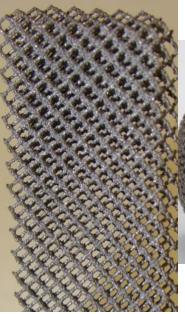
**Deposit Individual Layers** 







#### **Electron Beam Melting**







#### **Current Research:**

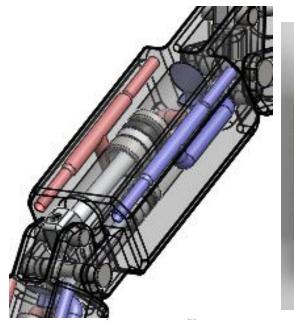
- Build of Parts Impossible or Near to Impossible to Build
- Implementation of Low-Cost Ti feedstock materials
  - 10X decrease in material cost
  - HDH CP Ti: Grade 3,4 Strength, Grade 1,2 Elongation
- Development of new Alloy Systems
  - Manage Machineable TiAI: EBM can improve existing alloys

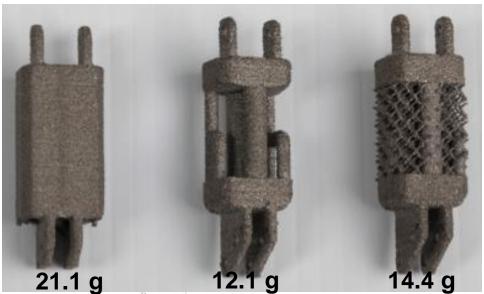


# Direct Manufacturing Utilizing New and Conventional Titanium Powders



- Graded Materials, Composites, and Improved Structures for Enhanced Performance
- Advanced Robotics
  - Aluminum finger (65 grams, \$6500 to fabricate)
  - Titanium finger (61 grams, \$20 worth of material)
- Advanced Design Structures
- Fast Design Iteration



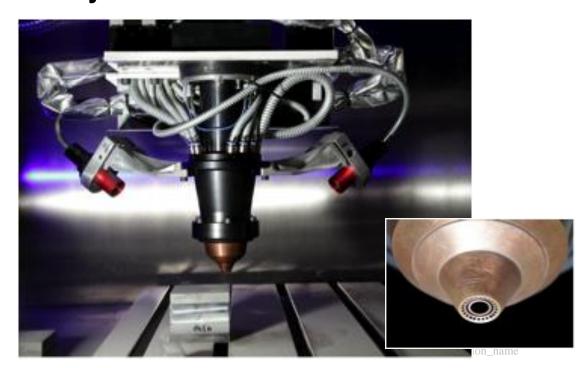


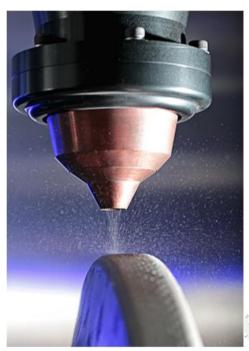


### **Laser Metal Deposition**



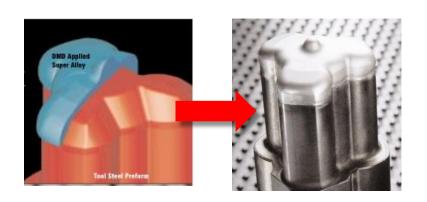
- Laser Beam melting of a continuously fed powder stream
- Site specific compositional control for production of functionally graded components with optimized properties
- Ability to add material to large parts including turbine blade repairs, surface treatments of dies, punches, and bits for increased wear ability and thermal behavior





#### **Laser Metal Deposition**

- Computer controlled 5-axis motion
- Inert chamber for reactive materials
- Closed Loop feedback system for precision deposition
- 2 powder hoppers allow for Multimaterial Deposition:

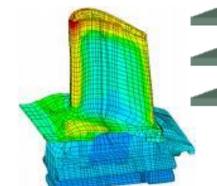






Laser Deposition, Composites for Application

- Graded Materials
- Coatings or Rebuilds
- Powder Metallurgy Versus Additive Manufacturing



Embedded Particle Arrays







Continually Graded



Discrete Zone



Complex Pattern



Complex Interface

Layered Hybrid Composites



Hard Surface



Embedded Layer



Multi-layer



Complex Interface

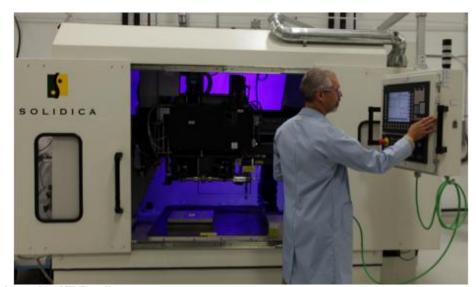


Laser Deposition of Reactive Materials



#### **Ultrasonic Additive Manufacturing**

- Ultrasonic Energy is used to bond thin tapes or sheets of material into 3-dimensional components
- Combination of additive and subtractive techniques allows precise machining of components with complex geometries and intricate internal channels
- Low temperature processing allows the ability to incorporate sensitive materials such as fiber optics for sensors







## **Advantages of a Ultrasonic Additive-Subtractive Deposition**

- Temperature Sensitive Materials
- Absent liquid-solid transformations
- Fast
- Lower energy consumption eco friendly
- Improved dimensional accuracy
- No atmosphere control requirements
- Well suited for joining of dissimilar metals







## **Ultrasonic Consolidation (Additive)**

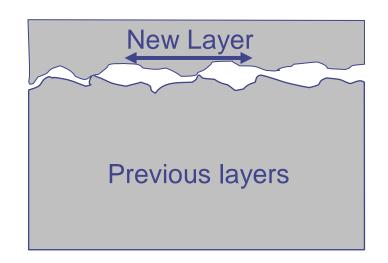
Ultrasonic energy transferred to material

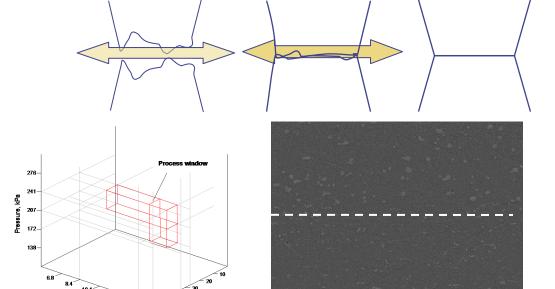
#### **Bond Stages**

Asperity collapse
Partial oxide disruption
Localized softening and
adhesion

#### **Key Parameters**

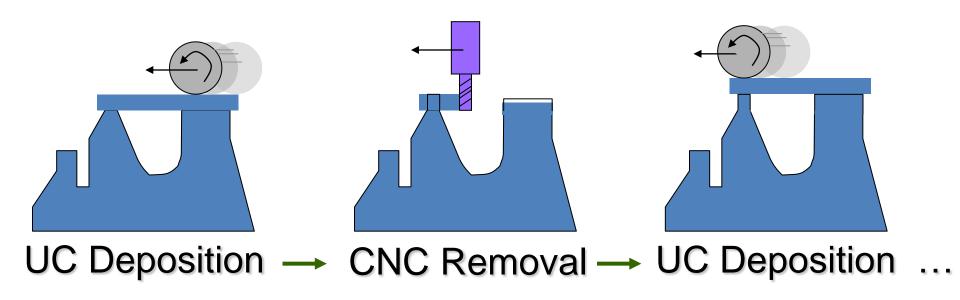
Amplitude (15µm)
Sonotrode force (500N)
Rolling speed (3cm/s)
Sonotrode texture
Frequency (20 kHz)
Power (3 kW)





## **Ultrasonic Consolidation (Subtractive)**

<u>Ultrasonic Consolidation</u> = Solid State Deposition + CNC Subtraction

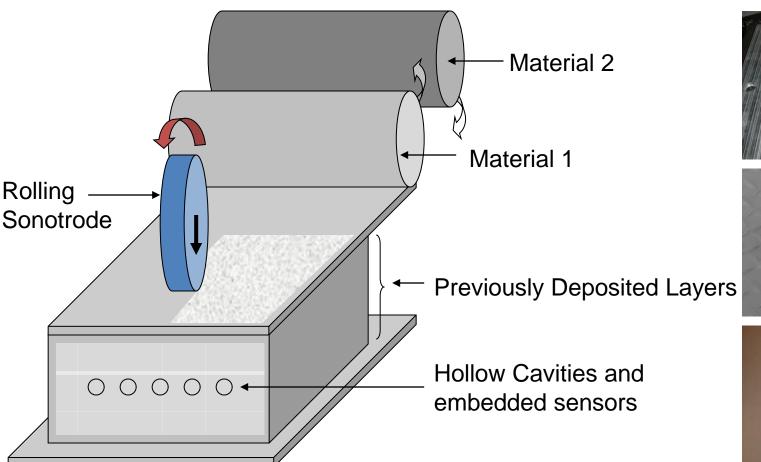


True metallurgical bond 8 layers Al, 100x





# Advanced Materials via Solid State or Ultrasonic Additive Manufacturing





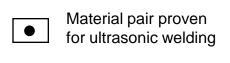




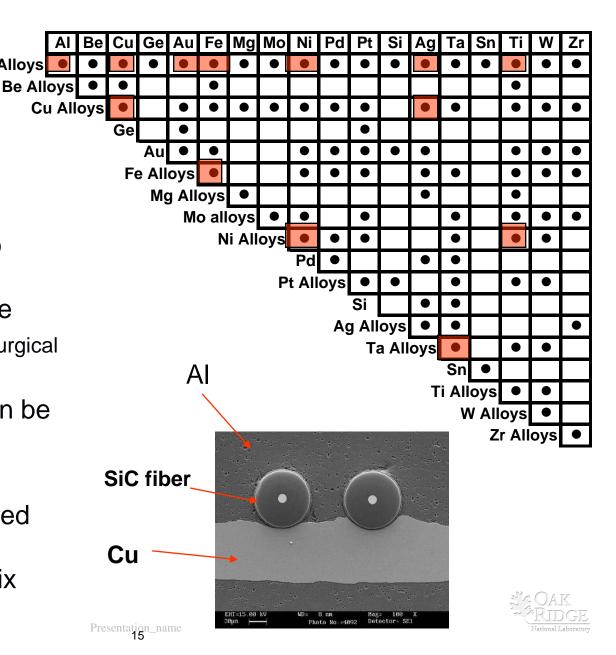


#### Dissimilar UC Matrix Potential

Al Alloys



- Material pair tested for UC
- Process well suited to dissimilar metals and multi-material laminate
  - No liquid phase metallurgical incompatibilities
- Multiple metal foils can be combined
- Fiberoptic, B and SiC fibers can be embedded without deleterious reactions with Al matrix



# **UC Part Examples**

